

INTERNATIONAL STANDARD

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Piezoelectric, dielectric and electrostatic oscillators of assessed quality –
Part 1: Generic specification

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Oscillateurs piézoélectriques, diélectriques et électrostatiques sous assurance
de la qualité – <https://standards.iteh.ai/catalog/standards/sist/37dc466f-20d8-42ef-8d83-ec51219/iec-60679-1-2017>
Partie 1: Spécification générique



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**Piezoelectric, dielectric and electrostatic oscillators of assessed quality –
Part 1: Generic specification**

**Oscillateurs piézoélectriques, diélectriques et électrostatiques sous assurance
de la qualité –**
Partie 1: Spécification générique

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CONTENTS

FOREWORD.....	4
1 Scope.....	6
2 Normative references	6
3 Terms, definitions and general information	7
3.1 General.....	7
3.2 Terms and definitions.....	7
3.3 Preferred values for ratings and characteristics	22
3.3.1 General	22
3.3.2 Climatic category (40/85/56).....	22
3.3.3 Bump severity.....	22
3.3.4 Vibration severity.....	22
3.3.5 Shock severity.....	23
3.3.6 Leak rate	23
3.4 Marking.....	23
3.4.1 General	23
3.4.2 Packaging.....	23
4 Quality assessment procedures	23
4.1 General.....	23
4.2 Primary stage of manufacture	24
4.3 Structurally similar components	24
4.4 Subcontracting.....	24
4.5 Incorporated components.....	24
4.6 Manufacturer's approval.....	24
4.7 Approval procedures.....	24
4.7.1 General	24
4.7.2 Capability approval	24
4.7.3 Qualification approval	25
4.8 Procedures for capability approval	25
4.8.1 General	25
4.8.2 Eligibility for capability approval.....	25
4.8.3 Application for capability approval	25
4.8.4 Granting of capability approval	25
4.8.5 Capability manual	25
4.9 Procedures for qualification approval	26
4.9.1 General	26
4.9.2 Eligibility for qualification approval.....	26
4.9.3 Application for qualification approval	26
4.9.4 Granting of qualification approval	26
4.9.5 Quality conformance inspection	26
4.10 Test procedures	26
4.11 Screening requirements	26
4.12 Rework and repair work	26
4.12.1 Rework	26
4.12.2 Repair work	26
4.13 Certified test records.....	27
4.14 Validity of release	27
4.15 Release for delivery	27

4.16	Unchecked parameters	27
Annex A (normative)	Load circuit for logic drive	28
A.1	TTL and Schottky	28
A.2	CMOS	30
A.3	ECL	30
A.4	LVDS	31
Annex B (normative)	Latch-up test	32
B.1	Definition	32
B.1.1	Latch-up	32
B.1.2	Test procedure	32
B.2	Test method	32
Annex C (normative)	Electrostatic discharge sensitivity classification	33
C.1	Definition	33
C.1.1	Electrostatic discharge (ESD)	33
C.1.2	Test procedure	33
C.2	Test methods	33
C.2.1	General	33
C.2.2	Leaded oscillator	33
C.2.3	SMD oscillator	33
C.2.4	The impact of ESD on Oscillator in steady-state	33
Annex D (normative)	Digital interfaced crystal oscillator's function	34
Bibliography	35
Figure 1	– Basic configurations of SAW resonators	9
Figure 2	– Example of the use of frequency offset	11
Figure 3	– Linearity of frequency modulation deviation	16
Figure 4	– Characteristics of an output waveform	18
Figure 5	– Definition of start-up time	19
Figure 6	– Clock signal with period jitter	19
Figure 7	– Phase jitter measures	20
Figure 8	– Gaussian distribution of jitter	20
Figure 9	– Jitter amplitude and period of jitter frequency	21
Figure 10	– Jitter tolerance according to ITU-T G.825, ATIS-0900101, Telcordia GR-253 and ETSI EN 300 462	21
Figure A.1	– Circuit for TTL	28
Figure A.2	– Circuit for Schottky logic	29
Figure A.3	– Circuit for PECL	30
Figure A.4	– Circuit for LVDS	31
Table A.1	– Values to be used when calculating R_1 and R_2	30
Table A.2	– Operating condition	31
Table A.3	– DC Electrical characteristics output load = 50 Ω to V_{cc} -2V	31
Table D.1	– Function of the digital interface	34

INTERNATIONAL ELECTROTECHNICAL COMMISSION

**PIEZOELECTRIC, DIELECTRIC AND ELECTROSTATIC
OSCILLATORS OF ASSESSED QUALITY –****Part 1: Generic specification**

FOREWORD

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International Standard IEC 60679-1 has been prepared by IEC technical committee TC 49: Piezoelectric, dielectric and electrostatic devices and associated materials for frequency control, selection and detection.

This bilingual version (2019-07) corresponds to the monolingual English version, published in 2017-07.

This fourth edition cancels and replaces the third edition published in 2007. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) the title has been changed;
- b) additional matters related to oscillator using SAW or MEMS resonator in "Terms, definitions and general information" have been included;
- c) measurement methods of IEC 60679-1:2007 have been removed (they will be moved to IEC 62884 series);
- d) the content of Annex A has been extended;
- e) a new term and definition DIXO (Digital interfaced Crystal Oscillator) has been added;
- f) a new term and definition SSSO (Spread Spectrum Crystal Oscillator) has been added;
- g) Annex D has been added.

The text of this standard is based on the following documents:

FDIS	Report on voting
49/1229/FDIS	49/1233/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

The French version of this standard has not been voted upon.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of the IEC 60679 series, published under the general title *piezoelectric, dielectric and electrostatic oscillators of assessed quality* can be found on the IEC website.

Future standards in this series will carry the new general title as cited above. Titles of existing standards in this series will be updated at the time of the next edition.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

PIEZOELECTRIC, DIELECTRIC AND ELECTROSTATIC OSCILLATORS OF ASSESSED QUALITY –

Part 1: Generic specification

1 Scope

This part of IEC 60679 specifies general requirements for piezoelectric, dielectric and electrostatic oscillators, including Dielectric Resonator Oscillators (DRO) and oscillators using FBAR (hereinafter referred to as "Oscillator"), of assessed quality using either capability approval or qualification approval procedures.

NOTE Dielectric Resonator Oscillators (DRO) and oscillators using FBAR are under consideration.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60027 (all parts), *Letter symbols to be used in electrical technology*

IEC 60050-561, *International electrotechnical vocabulary – Part 561: Piezoelectric, dielectric and electrostatic devices and associated materials for frequency control, selection and detection*. Available at www.electropedia.org

IEC 60469, *Transitions, pulses and related waveforms – Terms, definitions and algorithms*

IEC 60617, *Graphical symbols for diagrams*. Available at <http://std.iec.ch/iec60617>

IEC 60748-2, *Semiconductor devices – Integrated circuits – Part 2: Digital integrated circuits*

IEC 60749-26, *Semiconductor devices – Mechanical and climatic test methods – Part 26: Electrostatic discharge (ESD) sensitivity testing – Human body model (HBM)*

IEC 60749-27, *Semiconductor devices – Mechanical and climatic test methods – Part 27: Electrostatic discharge (ESD) sensitivity testing – Machine model (MM)*

IEC TR 61000-4-1, *Electromagnetic compatibility (EMC) – Part 4-1: Testing and measurement techniques – Overview of the IEC 61000-4 series*

IEC 61340-5-1, *Electrostatics – Part 5-1: Protection of electronic devices from electrostatic phenomena – General requirements*

IEC 62884-1:2017, *Measurement techniques of piezoelectric, dielectric, and electrostatic oscillators – Part 1: Basic methods for the measurement*

ISO 80000-1, *Quantities and units – Part 1: General*

Where any discrepancies occur for any reason, documents shall rank in the following order of precedence:

- detail specification;
- sectional specification;
- generic specification;
- any other international documents (for example of the IEC) to which reference is made.

The same order of precedence shall apply to equivalent national documents.

3 Terms, definitions and general information

3.1 General

Units, graphical symbols, letter symbols and terminology shall, wherever possible, be taken from the following standards:

- IEC 60027;
- IEC 60050-561;
- IEC 60469;
- IEC 60617;
- ISO 80000-1.

3.2 Terms and definitions

For the purposes of this document, the following terms and definitions apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at <http://www.electropedia.org/>
- ISO Online browsing platform: available at <http://www.iso.org/obp>

3.2.1

simple packaged crystal oscillator SPXO

crystal controlled oscillator having no means of temperature control or compensation, exhibiting a frequency/temperature characteristic determined substantially by the quartz crystal resonator employed

[SOURCE: IEC 60050-561:2014, 561-03-30]

3.2.2

overtone crystal controlled oscillator

oscillator designed to operate with the controlling piezoelectric resonator functioning in a specified mechanical overtone order of vibration

[SOURCE: IEC 60050-561:2014, 561-03-20, modified – The word "functioning" has been added.]

3.2.3

crystal cut

orientation of the crystal element with respect to the crystallographic axes of the crystal

Note 1 to entry: It can be desirable to specify the cut (and hence the general form of the frequency/temperature performance) of a crystal unit used in an oscillator application. The choice of the crystal cut will imply certain attributes of the oscillator which may not otherwise appear in the detail specification.

[SOURCE: IEC 60050-561:2014, 561-03-04]

3.2.4 voltage controlled crystal oscillator VCXO

crystal controlled oscillator, the frequency of which can be deviated or modulated according to a specific relation, through application of a control voltage

[SOURCE: IEC 60050-561:2014, 561-03-41]

3.2.5 temperature compensated crystal oscillator TCXO

crystal controlled oscillator whose frequency deviation due to temperature is reduced by means of a compensation system, incorporated in the device

[SOURCE: IEC 60050-561:2014, 561-03-36]

3.2.6 oven controlled crystal oscillator OCXO

crystal controlled oscillator in which at least the piezoelectric resonator is temperature controlled

Note 1 to entry: This mode of operation ensures that the oscillator frequency will remain sensibly constant over the operating temperature range of the OCXO, therefore independent of the frequency/temperature characteristic of the crystal unit.

[SOURCE: IEC 60050-561:2014, 561-03-19, modified – The note to entry has been added.]

3.2.7 surface acoustic wave SAW

acoustic wave, propagating along the surface of an elastic substrate, the amplitude of which decays exponentially with substrate depth

[SOURCE: IEC 60050-561:2014, 561-01-86]

3.2.8 SAWR surface acoustic wave resonator SAW resonator

resonator using multiple reflections of surface acoustic waves

[SOURCE: IEC 60050-561:2014, 561-01-87, modified – The term "SAW resonator" has been added.]

3.2.9 one-port SAW resonator

SAW resonator having a pair of terminals

SEE: Figure 1a.

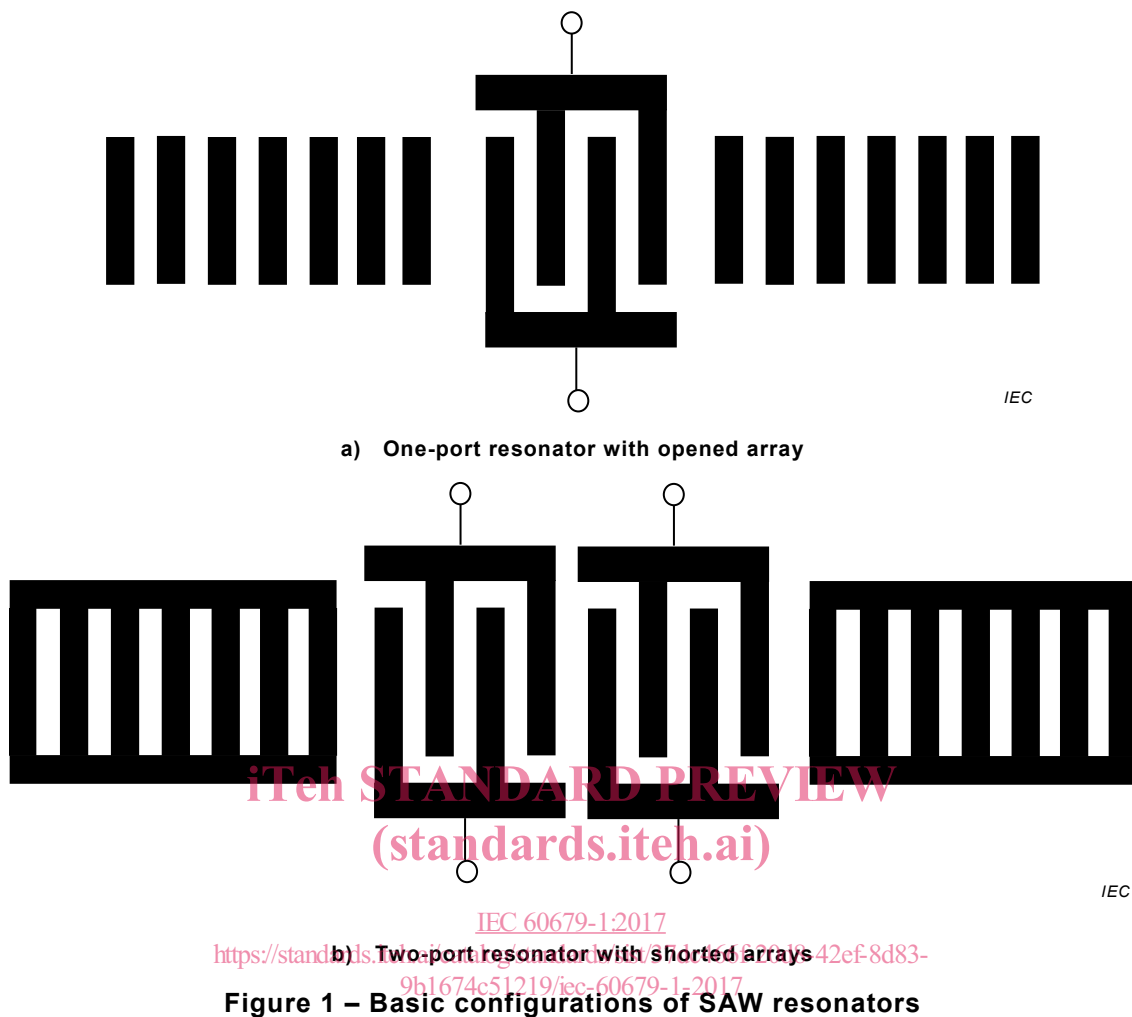
[SOURCE: IEC 60050-561:2014, 561-01-57, modified – The figure reference has been changed.]

3.2.10 two-port SAW resonator

SAW resonator having input and output ports

SEE: Figure 1b

[SOURCE: IEC 60050-561:2014, 561-01-94, modified – The figure reference has been changed.]

**3.2.11****SAW oscillator**

oscillator that uses a SAW resonator as the main frequency controlling element

3.2.12**simple packaged SAW oscillator****SPSO**

SAW oscillator having no means of temperature control or compensation, exhibiting a frequency/temperature characteristic determined substantially by SAW resonator employed

[SOURCE: IEC 60050-561:2014, 561-03-30, modified – change from crystal oscillator to SAW oscillator and from crystal resonator to SAW resonator.]

3.2.13**voltage controlled SAW oscillator****VCSSO**

SAW oscillator, the frequency of which can be deviated or modulated according to a specific relation, through application of a control voltage

[SOURCE: IEC 60050-561:2014, 561-03-41, modified – change from crystal resonator to SAW oscillator.]

3.2.14
temperature compensated SAW oscillator
TCSO

SAW oscillator whose frequency deviation due to temperature is reduced by means of a compensation system incorporated in the device

[SOURCE: IEC 60050-561:2014, 561-03-36, modified – change from crystal resonator to SAW oscillator.]

3.2.15
electrostatic micro electro mechanical system oscillator
electrostatic MEMS oscillator

oscillator that uses a MEMS device as the main frequency controlling element

3.2.16
voltage controlled electrostatic MEMS oscillator

electrostatic MEMS oscillator, the frequency of which can be deviated or modulated according to a specified relation, by application of a control voltage

[SOURCE: IEC 60050-561:2014, 561-03-41, modified – change from crystal to MEMS oscillator.]

3.2.17
digital interfaced crystal oscillator
DIXO

crystal oscillator, the frequency and the functions of which can be controlled, by application of an external digital signal

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Note 1 to entry: It will be combined as DI-TCXO in TCXO and as DI-OCXO in OCXO.

[IEC 60679-1:2017](#)

3.2.18
spread spectrum crystal oscillator
SSXO

<https://standards.iteh.ai/catalog/standards/sist/37dc466f-20d8-42ef-8d83-301674c51219/iec-60679-1-2017>

crystal oscillator that reduces the peak of frequency spectrum by modulating the oscillation frequency

3.2.19
nominal frequency

frequency given by the manufacturer or the specification to identify the oscillator

[SOURCE: IEC 60050-561:2014, 561-02-31, modified – The word "filter" has been replaced by" oscillator".]

3.2.20
frequency tolerance

maximum permissible deviation of a specified characteristic frequency from the specified value due to a specific cause, or a combination of causes

Note 1 to entry: Frequency tolerances are often assigned separately to specified ambient effects, namely electrical, mechanical and environmental. When this approach is used, it is necessary to define the values of other operating parameters as well as the range of the specified variable, that is to say:

- deviation from the frequency at the specified reference temperature due to operation over the specified temperature range, other conditions remaining constant;
- deviation from the frequency at the specified supply voltage due to supply voltage changes over the specified range, other conditions remaining constant;
- deviation from the initial frequency due to ageing, other conditions remaining constant;
- deviation from the frequency with specified load conditions due to changes in load impedance over the specified range, other conditions remaining constant.

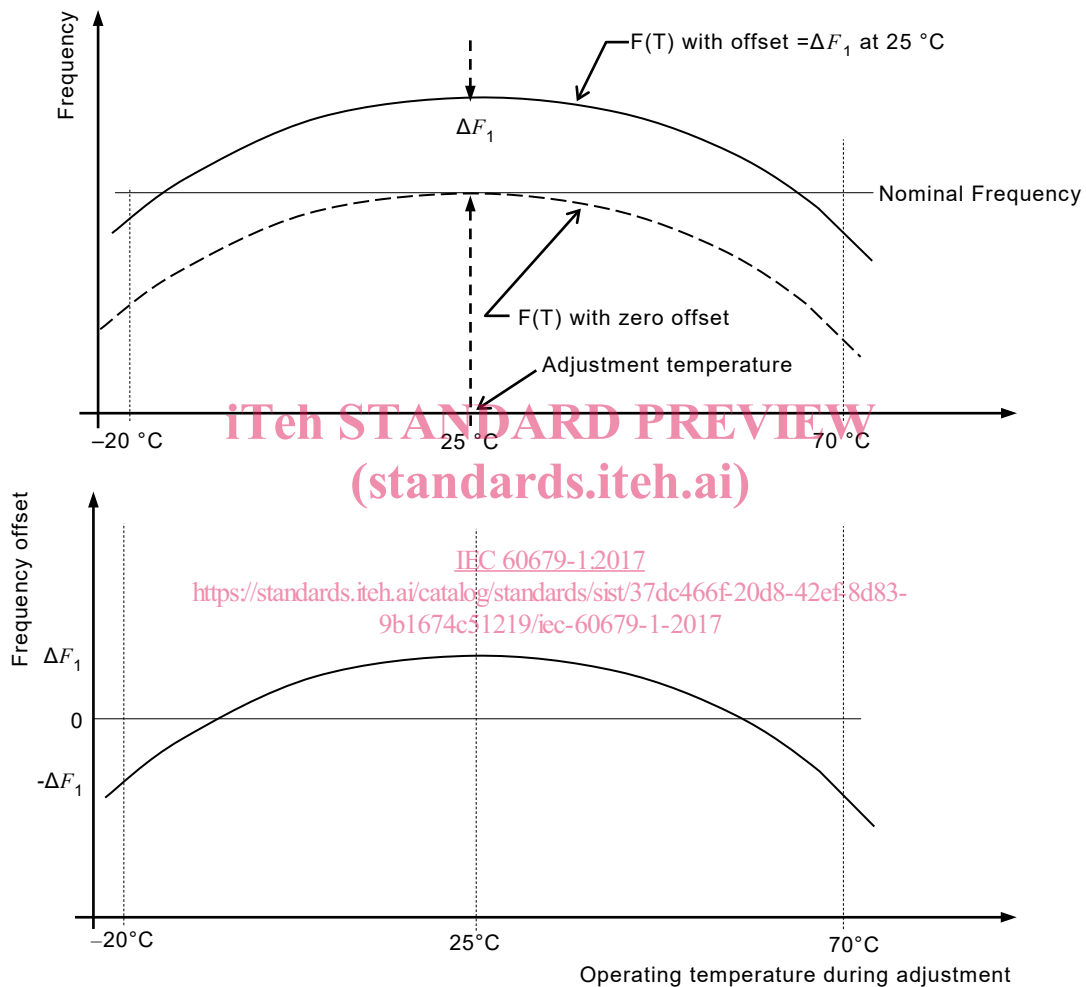
In some cases, an overall frequency tolerance may be specified, due to any/all combinations of operating parameters, during a specified lifetime.

[SOURCE: IEC 60050-561:2014, 561-01-33, modified – Note 1 to entry has been added.]

3.2.21 frequency offset

frequency difference, positive or negative, which should be added to the specified nominal frequency of Oscillator, when adjusting the Oscillator frequency under a particular set of operating conditions in order to minimize its deviation from nominal frequency over the specified range of operating conditions

Note 1 to entry: In order to minimize the frequency deviation from nominal over the entire temperature range, a frequency offset may be specified for adjustment at the reference temperature (see Figure 2).



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Figure 2 – Example of the use of frequency offset

[SOURCE: IEC 60050-561:2014, 561-03-09]

3.2.22 adjustment frequency

frequency to which an oscillator must be adjusted, under a particular combination of operating conditions, in order to meet the frequency tolerance specification over the specified range of operating conditions

Note 1 to entry: Adjustment frequency corresponds to nominal frequency plus frequency offset.

[SOURCE: IEC 60050-561:2014, 561-03-01]

3.2.23**frequency adjustment range**

range over which oscillator frequency may be varied by means of some variable element, for the purpose of

- a) setting the frequency to a particular value, or
- b) to correct oscillator frequency to a prescribed value after deviation due to ageing, or other changed conditions

Note 1 to entry: For test procedures – see 4.5.11 of IEC 62884-1:2017.

[SOURCE: IEC 60050-561:2014, 561-04-1003-07, modified – Note 1 to entry has been added.]

3.2.24**storage temperature range**

minimum and maximum temperatures as measured on the enclosure at which an oscillator may be stored without deterioration or damage to its performance

[SOURCE: IEC 60050-561:2014, 561-02-67, modified – The word "the device" has been replaced by "an oscillator".]

3.2.25**operating temperature range**, <of an oscillator>

range of temperatures over which the oscillator will function, maintaining frequency and other output signal characteristics within specified tolerances

[SOURCE: IEC 60050-561:2014, 561-03-18]

3.2.26**operable temperature range**

range of temperatures over which the oscillator will continue to provide an output signal, though not necessarily within the specified tolerances of frequency, level, waveform, etc.

[SOURCE: IEC 60050-561:2014, 561-01-58, modified – Some elements and specifications have been changed from resonator to Oscillator.]

3.2.27**reference temperature**

temperature at which certain Oscillator performance parameters are measured

Note 1 to entry: The reference temperature is normally $25\text{ °C} \pm 2\text{ °C}$.

[SOURCE: IEC 60050-561:2014, 561-03-25]

3.2.28**reference point temperature**

temperature measured at a specific reference point relative to an oscillator

[SOURCE: IEC 60050-561:2014, 561-03-24]

3.2.29**thermal transient frequency stability**

oscillator frequency time response when ambient temperature is changed from one specified temperature to another with a specific rate

[SOURCE: IEC 60050-561:2014, 561-03-37]

3.2.30 stabilization time

duration, measured from the initial application of power, required for an oscillator to stabilize its operation within specified limits

Note 1 to entry: For test procedures – see 4.5.10 of IEC 62884-1:2017.

[SOURCE: IEC 60050-561:2014, 561-03-33, modified – Note 1 to entry has been added.]

3.2.31 frequency/temperature characteristics

deviation from the frequency at the specified reference temperature due to operation over the specified temperature range, other conditions remaining constant

Note 1 to entry: For test procedures – see 4.5.5 of IEC 62884-1:2017.

3.2.32 frequency/temperature stability

maximum permissible deviation of the oscillator frequency, with no reference implied, due to operation over the specified temperature range at nominal supply and load conditions, other conditions constant

$$f - T_{\text{stability}} = \pm \frac{(f_{\text{max}} - f_{\text{min}})}{(f_{\text{max}} + f_{\text{min}})}$$

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where

f_{max} is the maximum frequency measured during the temperature run,

f_{min} is the minimum frequency measured during the temperature run

Note 1 to entry: For test procedures – see 4.5.5 of IEC 62884-1:2017

[SOURCE: MIL-PRF-55310E w/Amendment 2:2014]

3.2.33 frequency/voltage coefficient

fractional change in output frequency resulting from an incremental change in supply voltage, other parameters remaining unchanged

Note 1 to entry: In the case of OCXOs, a considerable time may elapse before the full effect of a supply voltage change is observed, as the temperature of the oven may drift gradually to a new value following the voltage perturbation.

Note 2 to entry: For test procedures – see 4.5.7 of IEC 62884-1:2017.

[SOURCE: IEC 60050-561:2014, 561-03-11, modified – Note 2 to entry has been added.]

3.2.34 frequency/load coefficient

fractional change in output frequency resulting from an incremental change in electrical load impedance, other parameters remaining unchanged

Note 1 to entry: For test procedures – see 4.5.6 of IEC 62884-1:2017.

[SOURCE: IEC 60050-561:2014, 561-03-08, modified – Note 1 to entry has been added.]